

AUTOMOTIVE GRADE

AUIRLZ44Z

HEXFET® Power MOSFET

Features

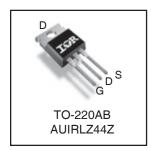
- Advanced Process Technology
- Ultra Low On-Resistance
- 175°C Operating Temperature
- Fast Switching
- Repetitive Avalanche Allowed up to Timax
- Lead-Free, RoHS Compliant
- Automotive Qualified *

G

$ V_{(BR)DSS} $	3	55V
R _{DS(on)}	typ.	11m Ω
	max.	13.5m Ω
I _D		51A

Description

Specifically designed for Automotive applications, this HEXFET® Power MOSFET utilizes the latest processing techniques to achieve extremely low onresistance per silicon area. Additional features of this design are a 175°C junction operating temperature, fast switching speed and improved repetitive avalanche rating . These features combine to make this design an extremely efficient and reliable device for use in Automotive applications and a wide variety of other applications.



G	D	S
Gate	Drain	Source

Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (T_A) is 25°C, unless otherwise specified.

	Parameter	Max.	Units
	Continuous Drain Current, V _{GS} @ 10V	51	
I _D @ T _C = 100°C	Continuous Drain Current, V _{GS} @ 10V	36	Α
I _{DM}	Pulsed Drain Current ①	204	1
P _D @T _C = 25°C	Power Dissipation	80	W
	Linear Derating Factor	0.53	W/°C
V_{GS}	Gate-to-Source Voltage	± 16	V
E _{AS(Thermally Limited)}	Single Pulse Avalanche Energy ^②	78	mJ
E _{AS} (tested)	Single Pulse Avalanche Energy Tested Value ®	110	
I _{AR}	Avalanche Current ①	See Fig.12a, 12b, 15, 16	Α
E _{AR}	Repetitive Avalanche Energy (9		mJ
T_J	Operating Junction and	-55 to + 175	
T _{STG}	Storage Temperature Range		°C
	Soldering Temperature, for 10 seconds (1.6mm from case)	300	
	Mounting Torque, 6-32 or M3 screw	10 lbf•in (1.1N•m)	

Thermal Resistance

	Parameter	Тур.	Max.	Units
$R_{\theta JC}$	Junction-to-Case ⑦		1.87	
$R_{\theta CS}$	Case-to-Sink, Flat Greased Surface	0.50		°C/W
$R_{\theta JA}$	Junction-to-Ambient		62	

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^{*}Qualification standards can be found at http://www.irf.com/



Static Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
$V_{(BR)DSS}$	Drain-to-Source Breakdown Voltage	55			V	$V_{GS} = 0V, I_D = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient		0.05		V/°C	Reference to 25°C, I _D = 1mA
R _{DS(on)}	Static Drain-to-Source On-Resistance		11	13.5	mΩ	V _{GS} = 10V, I _D = 31A ③
				20	mΩ	$V_{GS} = 5.0V, I_D = 30A$ ③
				22.5	mΩ	$V_{GS} = 4.5V, I_D = 15A$ ③
$V_{GS(th)}$	Gate Threshold Voltage	1.0		3.0	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
gfs	Forward Transconductance	27			V	$V_{DS} = 25V, I_{D} = 31A$
I _{DSS}	Drain-to-Source Leakage Current			20	μΑ	$V_{DS} = 55V$, $V_{GS} = 0V$
				250	İ	$V_{DS} = 55V, V_{GS} = 0V, T_{J} = 125^{\circ}C$
I _{GSS}	Gate-to-Source Forward Leakage			200	nA	V _{GS} = 16V
	Gate-to-Source Reverse Leakage			-200		V _{GS} = -16V

Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

						<u> </u>
	Parameter	Min.	Тур.	Max.	Units	Conditions
Q_g	Total Gate Charge		24	36		$I_D = 31A$
Q_{gs}	Gate-to-Source Charge		7.5		nC	$V_{DS} = 44V$
Q_{gd}	Gate-to-Drain ("Miller") Charge		12			V _{GS} = 5.0V ③
t _{d(on)}	Turn-On Delay Time		14			$V_{DD} = 50V$
t _r	Rise Time		160			$I_D = 31A$
t _{d(off)}	Turn-Off Delay Time		25		ns	$R_G = 7.5 \Omega$
t _f	Fall Time		42			V _{GS} = 5.0V ③
L _D	Internal Drain Inductance		4.5			Between lead,
					nН	6mm (0.25in.)
L _S	Internal Source Inductance		7.5			from package
						and center of die contact
C _{iss}	Input Capacitance		1620			$V_{GS} = 0V$
C _{oss}	Output Capacitance		230			$V_{DS} = 25V$
C _{rss}	Reverse Transfer Capacitance		130		pF	f = 1.0MHz
Coss	Output Capacitance		860			$V_{GS} = 0V, V_{DS} = 1.0V, f = 1.0MHz$
C _{oss}	Output Capacitance		180			$V_{GS} = 0V, V_{DS} = 44V, f = 1.0MHz$
C _{oss} eff.	Effective Output Capacitance		280			$V_{GS} = 0V$, $V_{DS} = 0V$ to 44V $\textcircled{4}$

Diode Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions
I _S	Continuous Source Current			51		MOSFET symbol
	(Body Diode)				Α	showing the
I _{SM}	Pulsed Source Current			204		integral reverse
	(Body Diode) ①					p-n junction diode.
V_{SD}	Diode Forward Voltage			1.3	V	$T_J = 25$ °C, $I_S = 31A$, $V_{GS} = 0V$ ③
t _{rr}	Reverse Recovery Time		21	32		$T_J = 25$ °C, $I_F = 31A$, $V_{DD} = 28V$
Q_{rr}	Reverse Recovery Charge		16	24	nC	di/dt = 100A/µs ③
t _{on}	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

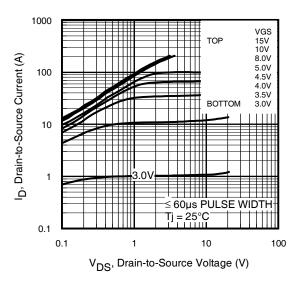
Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11).
- ② Limited by T_{Jmax} , starting $T_J = 25^{\circ}C$, L = 0.166mH $R_G = 25\Omega$, $I_{AS} = 31A$, $V_{GS} = 10V$. Part not recommended for use above this value.
- $\ \, \mbox{$\Phi$} \ \, C_{oss}$ eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS} .
- S Limited by T_{Jmax}, see Fig.12a, 12b, 15, 16 for typical repetitive avalanche performance.
- $\ \ \,$ This value determined from sample failure population, starting T $_J$ = 25°C, L = 0.166mH, R $_G$ = 25 Ω , I $_{AS}$ = 31A, V $_{GS}$ =10V.
- $\ensuremath{\mathfrak{D}}$ R_θ is measured at T_J approximately 90°C.

Qualification Information[†]

			Automotive (per AEC-Q101) ††			
Qualification I	Level	Comments: This part number(s) passed Auton qualification. IR's Industrial and Consumer qualification is granted by extension of the higher Auton level.				
Moisture Sens	sitivity Level	TO-220AB	N/A			
	Machine Model		Class M4(+/- 425V) ^{†††} (per AEC-Q101-002)			
ESD	Human Body Model		Class H1C(+/- 2000V) ^{†††} (per AEC-Q101-001)			
	Charged Device Model		Class C5(+/- 1125V) ^{†††} (per AEC-Q101-005)			
RoHS Complia	ant		Yes			

- † Qualification standards can be found at International Rectifier's web site: http://www.irf.com/
- †† Exceptions to AEC-Q101 requirements are noted in the qualification report.
- ††† Highest passing voltage



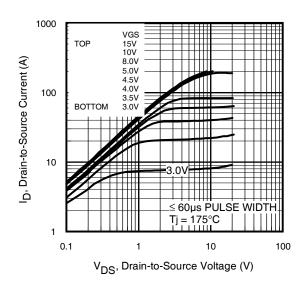
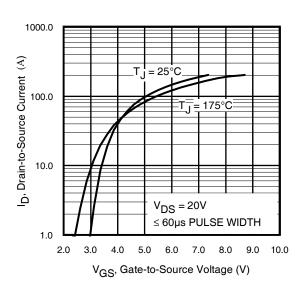


Fig 1. Typical Output Characteristics

Fig 2. Typical Output Characteristics



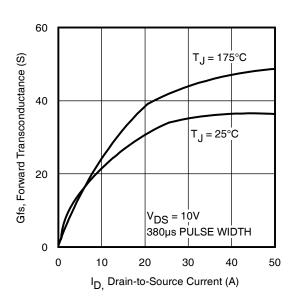
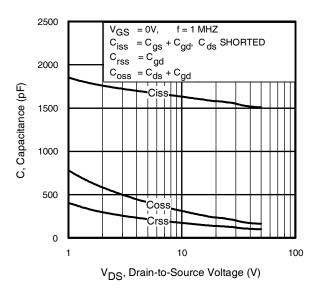


Fig 3. Typical Transfer Characteristics

Fig 4. Typical Forward Transconductance Vs. Drain Current



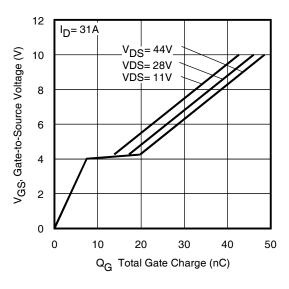


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

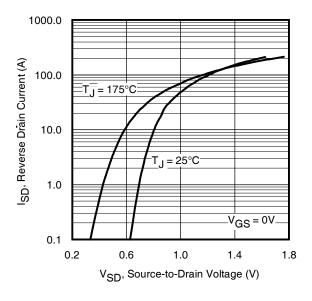


Fig 7. Typical Source-Drain Diode Forward Voltage

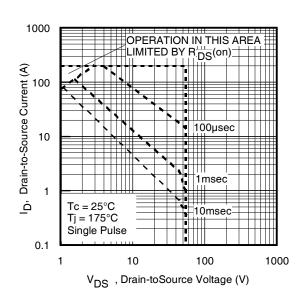


Fig 8. Maximum Safe Operating Area

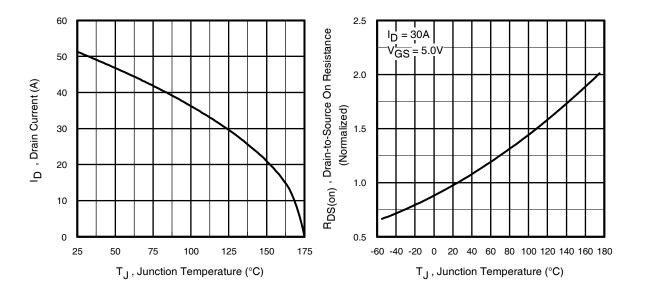


Fig 9. Maximum Drain Current Vs. Case Temperature

Fig 10. Normalized On-Resistance Vs. Temperature

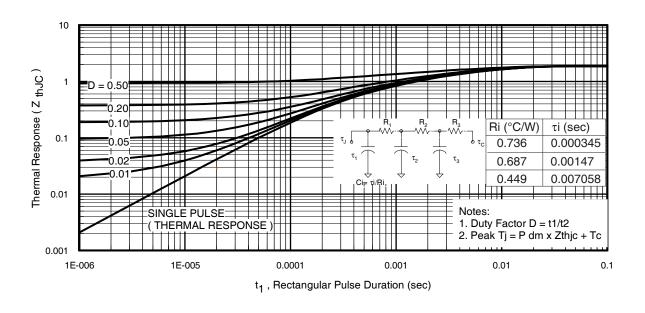


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

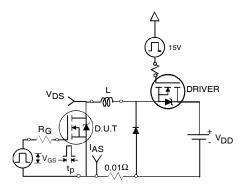


Fig 12a. Unclamped Inductive Test Circuit

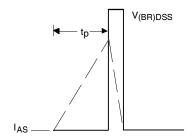


Fig 12b. Unclamped Inductive Waveforms

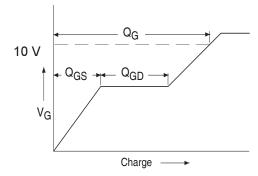


Fig 13a. Basic Gate Charge Waveform

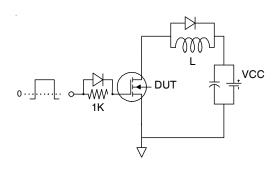


Fig 13b. Gate Charge Test Circuit www.irf.com

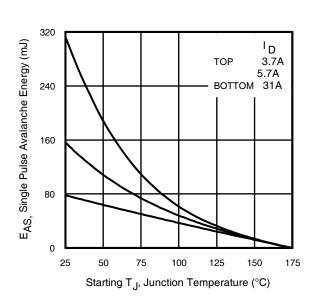


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

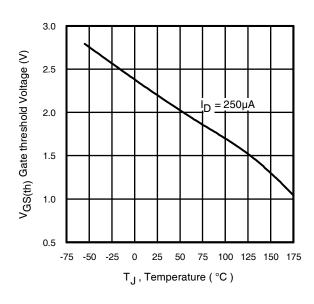


Fig 14. Threshold Voltage Vs. Temperature

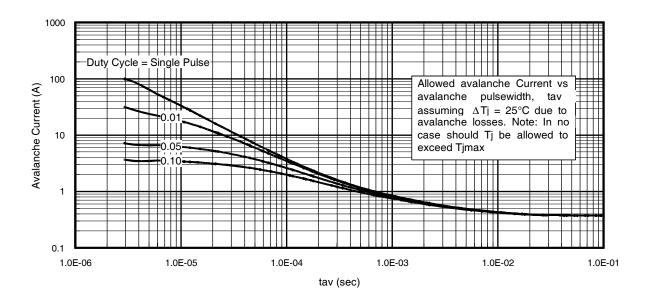
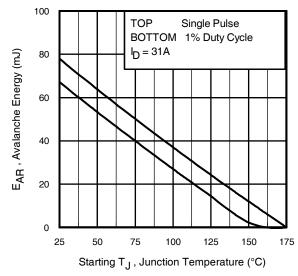


Fig 15. Typical Avalanche Current Vs. Pulsewidth



Notes on Repetitive Avalanche Curves, Figures 15, 16: (For further info, see AN-1005 at www.irf.com)

- Avalanche failures assumption:
 - Purely a thermal phenomenon and failure occurs at a temperature far in excess of T_{jmax} . This is validated for every part type.
- 2. Safe operation in Avalanche is allowed as long asT_{jmax} is not exceeded.
- Equation below based on circuit and waveforms shown in Figures 12a, 12b.
- 4. P_{D (ave)} = Average power dissipation per single avalanche pulse.
- BV = Rated breakdown voltage (1.3 factor accounts for voltage increase during avalanche).
- 6. I_{av} = Allowable avalanche current.
- 7. ΔT = Allowable rise in junction temperature, not to exceed T_{jmax} (assumed as 25°C in Figure 15, 16).
- t_{av =} Average time in avalanche.
- D = Duty cycle in avalanche = $t_{av} \cdot f$

 $Z_{thJC}(D, t_{av})$ = Transient thermal resistance, see figure 11)

$$\begin{split} P_{D \text{ (ave)}} &= 1/2 \text{ (} 1.3 \cdot \text{BV} \cdot I_{aV}) = \triangle T / \text{ Z_{thJC}} \\ I_{av} &= 2\triangle T / \text{ [} 1.3 \cdot \text{BV} \cdot \text{Z_{th}]} \\ E_{AS \text{ (AR)}} &= P_{D \text{ (ave)}} \cdot t_{av} \end{split}$$

Fig 16. Maximum Avalanche Energy Vs. Temperature

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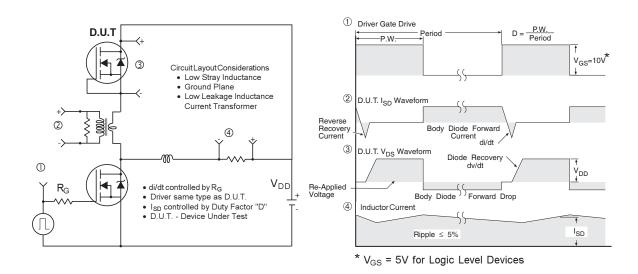


Fig 17. Diode Reverse Recovery Test Circuit for N-Channel HEXFET® Power MOSFETs

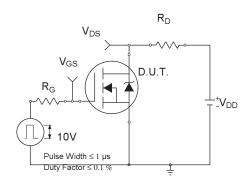


Fig 18a. Switching Time Test Circuit

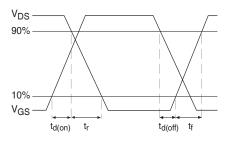
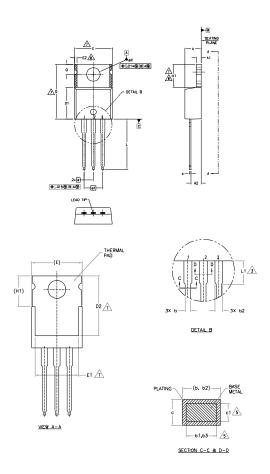


Fig 18b. Switching Time Waveforms

TO-220AB Package Outline

Dimensions are shown in millimeters (inches)



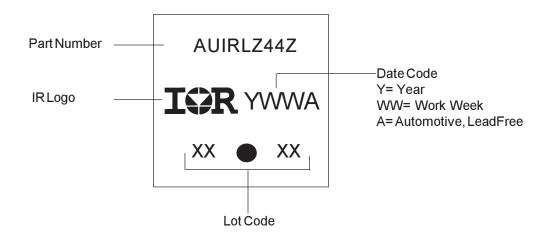
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 DIVENSIONING AND TOLERANCING AS PER ASNE Y14,5 M- 1994,
 DIVENSIONS ARE SHOWN IN INCHES [MILLIMETERS],
 LEAD DIVENSION AND FINSH UNCONTROLLED IN LI,
 DIVENSION D, JO & E DO NOT INCLIDE MODE INJSH, MOLD FLASH
 SHALL NOT EXCEED .005' (0,127) PER SIGE. HISSE DIVENSIONS ARE
 MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BOTY.
 DIVENSION D IN, B. & C I APPLY TO BASE WETAL CALLY
 CONTROLLING DIMENSION IN INDEED.
 THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS EMILDE & ET
 DIVENSION E S.Y HID ETEN E A ZOOK "HEREE STAMPING
 AND SHOULATION IRREGULARITIES ARE ALLOWED.
 UNLINE CONFORMS TO LEBECT 10-202, EXCEPT AZ (max.) AND DZ (min.)
 WHERE DIMENSIONS ARE DERIVED FROM THE ACTUAL PACKAGE OUTLINE.

SYMBOL	MILLIM	ETERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	NOTES
Α	3,56	4.83	,140	.190	
A1	0.51	1,40	.020	.055	
A2	2.03	2.92	.080	.115	
ь	0.38	1,01	.015	.040	
b1	0.38	0.97	.015	.038	5
b2	1,14	1.78	.045	.070	
b3	1,14	1,73	.045	.068	5
c	0.36	0.61	.014	.024	
c1	0.36	0.56	.014	.022	5
D	14.22	16,51	.560	.650	4
D1	8,38	9.02	,330	.355	
D2	11.68	12.88	.460	.507	7
E	9,65	10.67	.380	.420	4.7
E1	6.86	8.89	.270	.350	7
E2	-	0.76	-	.030	8
e	2.54	2.54 BSC 5.08 BSC		BSC BSC	
e1	5.08	BSC		BSC	
H1	5.84	6.86	.230	.270	7,8
L	12,70	14.73	.500	.580	
L1	3.56	4.06	.140	.160	3
øP	3.54	4.08	.139	.161	
Q	2.54	3.42	,100	.135	

LEAD ASSICNMENTS

TO-220AB Part Marking Information



TO-220AB packages are not recommended for Surface Mount Application.

Note: For the most current drawing please refer to IR website at http://www.irf.com/package/

International

TOR Rectifier

AUIRLZ44Z

Ordering Information

Base part number	Package Type	Standard Pack		Complete Part Number
		Form	Quantity	
AUIRLZ44Z	TO-220	Tube	50	AUIRLZ44Z

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